



SLOVENSKI STANDARD

SIST EN 62680-1-2:2017

01-maj-2017

Vmesniki univerzalnega serijskega vodila za prenos podatkov in napajanje - 1-2. del: Skupne komponente - Specifikacija za zagotavljanje napajanja prek USB (IEC 62680-1-2:2016)

Universal Serial Bus interfaces for data and power - Part 1-2: Common components - USB Power Delivery Specification (IEC 62680-1-2:2016)

Schnittstellen des Universellen Seriellen Busses für Daten und Energie - Teil 1-2: Gemeinsame Komponenten - USB Stromversorgungs-Spezifikation (IEC 62680-1-2:2016)

Interfaces bus série universel (USB) pour les données et l'alimentation électrique - Partie 1-2 : Composants communs - Spécification USB pour la fourniture de courant (IEC 62680-1-2:2016)

Ta slovenski standard je istoveten z: EN 62680-1-2:2017

ICS:

35.200	Vmesniška in povezovalna oprema	Interface and interconnection equipment
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EUROPEAN STANDARD

EN 62680-1-2

NORME EUROPÉENNE

EUROPÄISCHE NORM

January 2017

ICS 29.220; 33.120; 35.200

English Version

Universal serial bus interfaces for data and power - Part 1-2: Common components - USB Power Delivery specification (IEC 62680-1-2:2016)

Interfaces bus série universel (USB) pour les données et
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EN 62680-1-2:2017**European foreword**

The text of document 100/2728/CDV, future edition 1 of IEC 62680-1-2, prepared by IEC/TC 100 “Audio, video and multimedia systems and equipment” was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62680-1-2:2017.

The following dates are fixed:

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INTERNATIONAL STANDARD



**Universal serial bus interfaces for data and power –
Part 1-2: Common components – USB Power Delivery specification**

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INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

ICS 29.220; 33.120; 35.200

ISBN 978-2-8322-3710-6

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UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER

Part 1-2: Common components – USB Power Delivery specification

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International Standard IEC 62680-1-2 has been prepared by technical area 14: Interfaces and methods of measurement for personal computing equipment, of IEC technical committee 100: Audio, video and multimedia systems and equipment.

The text of this standard was prepared by the USB Implementers Forum (USB-IF). The structure and editorial rules used in this publication reflect the practice of the organization which submitted it.

The text of this standard is based on the following documents:

CDV	Report on voting
100/2728/CDV	100/2729/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

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The IEC 62680 series is based on a series of specifications that were originally developed by the USB Implementers Forum (USB-IF). These specifications were submitted to the IEC under the auspices of a special agreement between the IEC and the USB-IF.

This standard is the USB-IF publication USB Power Delivery Specification Revision 3.0 V.1.0.

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Universal Serial Bus Power Delivery Specification

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Revision 3.0, V1.0, 11 December 2015

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Richard Petrie	DisplayLink

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